

### STV300NH02L

# N-channel 24 V, 0.8 mΩ typ., 200 A STripFET™ III Power MOSFET in a PowerSO-10 package

Datasheet — production data

#### **Features**

Order code	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub>
STV300NH02L	24 V	0.001 Ω	200 A <sup>(1)</sup>

- 1. This value is limited by package
- R<sub>DS(on)</sub>\*Q<sub>g</sub> industry's benchmark
- Conduction losses reduced
- Low profile, very low parasitic inductance
- Switching losses reduced

### **Applications**

- Switching applications
  - OR-ing
- Specially designed and optimized for high efficiency DC/DC converters.

### **Description**

This N-channel enhancement mode Power MOSFET benefits from the latest refinement of STMicroelectronics' unique "single feature size" strip-based process, which decreases the critical alignment steps to offer exceptional manufacturing reproducibility. The result is a transistor with extremely high packing density for low on-resistance, rugged avalanche characteristics and low gate charge.

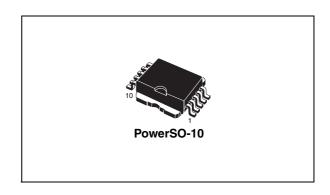


Figure 1. Internal schematic diagram

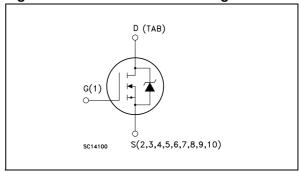


Figure 2. Connection diagram (top view)

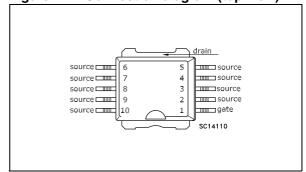


Table 1. Device summary

Order code	Marking	Package	Packaging
STV300NH02L	300NH02L	PowerSO-10	Tape and reel

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Content STV300NH02L

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STV300NH02L Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	24	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	200	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 100 °C	200	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	800	Α
P <sub>TOT</sub> (3)	Total dissipation at T <sub>C</sub> = 25°C	300	W
	Derating factor	2	W/°C
E <sub>AS</sub> (4)	Single pulse avalanche energy	1.6	J
T <sub>stg</sub>	Storage temperature -55 to 175		°C
T <sub>j</sub>	Operating junction temperature	-55 to 175	

- 1. This value is limited by package
- 2. Pulse with limited by safe operating area
- 3. This value is rated according to Rthj-c
- 4. Starting Tj =  $25^{\circ}$ C,  $I_D = 60$ A,  $V_{DD} = 20$ V

Table 3. Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case max	0.5	°C/W
Rthj-pcb (1)	Thermal resistance junction-pcb max	35	°C/W

1. When mounted on 1 inch2 FR-4, 2 oz Cu

Electrical characteristics STV300NH02L

### 2 Electrical characteristics

(Tcase =25°C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage (V <sub>GS</sub> = 0)	I <sub>D</sub> = 1 mA	24			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 24 V V <sub>DS</sub> = 24 V, T <sub>c</sub> =125 °C			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>DS</sub> = ± 20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1	1.5	2.5	٧
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS}$ = 5 V, $I_{D}$ = 40 A $V_{GS}$ = 10 V, $I_{D}$ = 80 A		1.15 0.8	1.5 1	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub>	Input capacitance Output capacitance Reverse transfer capacitance	V <sub>DS</sub> = 15V, f = 1 MHz, V <sub>GS</sub> =0	-	7055 3251 307	-	pF pF pF
Q <sub>g</sub> Q <sub>gs</sub> Q <sub>gd</sub>	Total gate charge Gate-source charge Gate-drain charge	$V_{DD}$ = 12V, $I_{D}$ = 120A, $V_{GS}$ = 10V (see Figure 15)	-	109 30 26	-	nC nC nC
R <sub>G</sub>	Gate input resistance	$V_{DS} = 0V$ , $f = 1$ MHz, $V_{GS} = 0$	-	4.4	-	Ω

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
t <sub>d(on)</sub>	Turn-on delay time Rise time	$V_{DD}$ = 12V, $I_D$ = 60A $R_G$ = 4.7 $\Omega$ $V_{GS}$ = 10V, (see Figure 14)	-	18 275	-	ns ns
t <sub>d(off)</sub>	Turn-off delay time Fall time	$V_{DD}$ = 12V, $I_D$ = 60A $R_G$ = 4.7 $\Omega$ $V_{GS}$ = 10V, (see Figure 14)	-	138 94.4	-	ns ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current Source-drain current (pulsed)		-		200 800	A A
V <sub>SD</sub> <sup>(1)</sup>	Forward on voltage	$I_{SD} = 120A, V_{GS} = 0$	-		1.3	٧
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD}$ = 120A, di/dt = 100A/ $\mu$ s $V_{DD}$ = 20V, $T_j$ = 25°C (see Figure 19)	-	63 85 2.7		ns nC A
t <sub>rr</sub> Q <sub>rr</sub> I <sub>RRM</sub>	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 120A$ , di/dt = 100A/ $\mu$ s $V_{DD} = 20V$ , $T_j = 150$ °C (see Figure 19)	-	63 88 2.8		ns nC A

<sup>1.</sup> Pulsed: Pulse duration = 300 μs, duty cycle 1.5%

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#### **Electrical characteristics (curves)** 2.1

Figure 3. Safe operating area

Figure 4. Thermal impedance

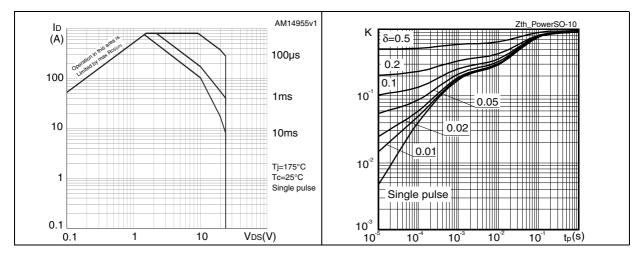


Figure 5. **Output characteristics** 

Figure 6. **Transfer characteristics** 

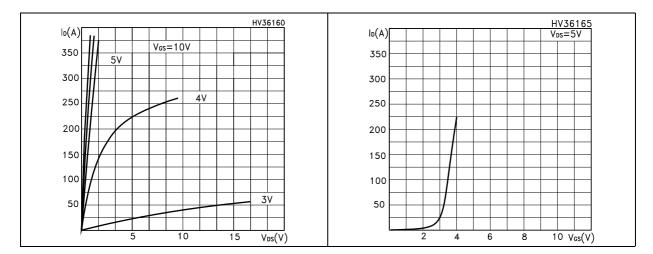


Figure 7. Figure 8. Normalized BV<sub>DSS</sub> vs temperature Static drain-source on-resistance

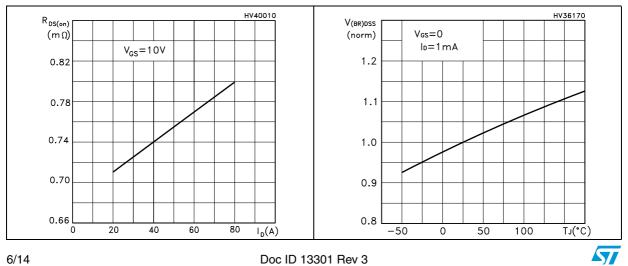


Figure 9. Gate charge vs gate-source voltage Figure 10. Capacitance variations

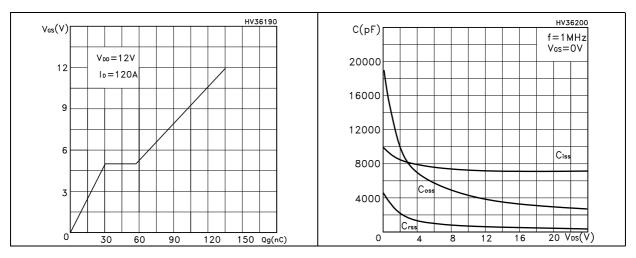


Figure 11. Normalized gate threshold voltage Figure 12. Normalized on-resistance vs vs temperature temperature

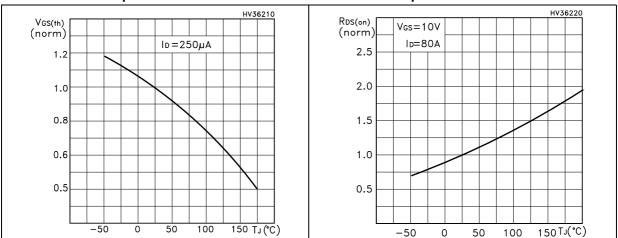
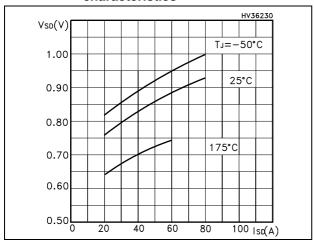


Figure 13. Source-drain diode forward characteristics



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Test circuits STV300NH02L

### 3 Test circuits

Figure 14. Switching times test circuit for resistive load

Figure 15. Gate charge test circuit

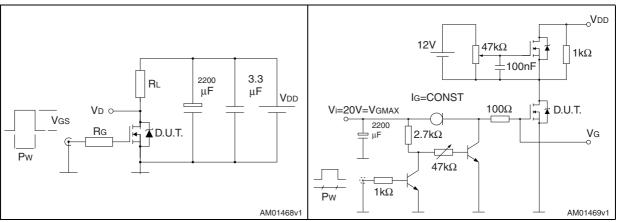


Figure 16. Test circuit for inductive load switching and diode recovery times

Figure 17. Unclamped inductive load test circuit

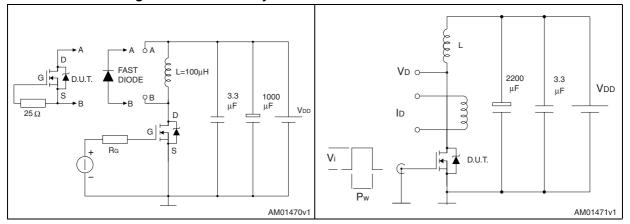
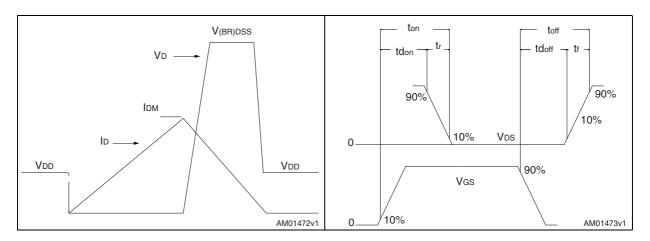


Figure 18. Unclamped inductive waveform

Figure 19. Switching time waveform



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## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK is an ST trademark.

Table 8. PowerSO-10 mechanical data

Dim.		mm	
Dim.	Min.	Тур.	Max.
А			3.70
A1	0.00		0.10
A2	3.40		3.60
A3	1.25		1.35
b	0.40		0.53
С	0.35		0.55
D	9.40		9.60
D1	7.40		7.60
E	13.80		14.40
E1	9.30		9.50
E2	7.20		7.60
E3	5.90		6.10
е		1.27	
L	0.95		1.65
<	0°		8°

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Figure 20. PowerSO-10 drawing

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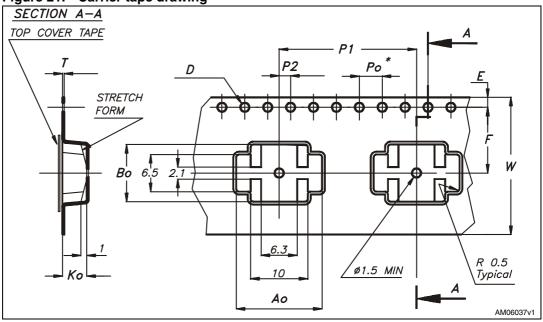
# 5 Packaging mechanical data

Table 9. Carrier tape dimensions

Ref.		mm	
nei.	Min.	Тур.	Max.
A0	14.9	15.0	15.1
В0	9.9	10.0	10.1
K0	4.15	4.25	4.35
F	11.4	11.5	11.6
E	1.65	1.75	1.85
W	23.7	24.0	24.3
P2	1.9	2.0	2.1
P0	3.9	4.0	4.1
P1	23.9	24.0	24.1
Т	0.025	0.30	0.35
D(Ø)	1.50	1.55	1.60

Note: 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$  mm.





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a. Drawing is not to scale.

Table 10. Reel dimensions

Ref.		mm	
nei.	Min.	Тур.	Max.
А			330
В	1.5		
С	12.8	13	13.2
D	20.2		
N	60		
G		24.4	
Т			30.4

Note: 10 sprocket hole pitch cumulative tolerance  $\pm 0.2$  mm.

Figure 22. Reel drawing (b)

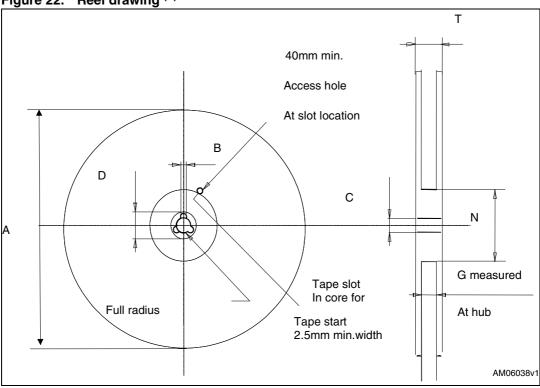


Table 11. Base/bulk quantities

Base qty.	Bulk qty.
600	

b. Drawing is not to scale.

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STV300NH02L Revision history

# 6 Revision history

Table 12. Revision history

Date	Revision	Changes
08-Feb-2007	1	First release
13-Sep-2007	2	New section has been added: 2.1: Electrical characteristics (curves).
10-Oct-2012	3	Updated Table 4: On /off states and Section 4: Package mechanical data.  Inserted Section 5: Packaging mechanical data.  Minor text changes.

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